Patent

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): James Baukus, et al.

Re: Information Disclosure

Statement

Serial No.: 09/696,826

Group: 2811

Filed: October 25, 2000

Examiner: Tran, Thien F.

For: "IMPLANTED HIDDEN

Our Ref: B-3650 617089-5

INTERCONNECTIONS IN A

Date: March 8, 2004

SEMICONDUCTOR DEVICE FOR

PREVENTING REVERSE ENGINEERING"

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the Applicants' duty to disclose information which may be material to the examination of this application, the undersigned respectfully requests that the Examiner consider on the merits the documents listed on the enclosed Form PTO-1449 (modified). We are enclosing herewith a copy of each document listed on the enclosed Form PTO-1449 (modified).

It should be noted that the above-identified application may be related by subject matter to the following U.S. Application(s): 08/869,824, filed June 6, 1997 (now U.S. Patent No. 5,973,375); 10/132,523, filed April 24, 2002; 10/735,841, filed December 12, 2003; and 09/882,892, filed on June 15, 2001. Pursuant to 37 C.F.R. 1.56(a) and M.P.E.P. 2004, paragraph 9, the applicant brings these co-pending applications to the attention of the Examiner. The Examiner should consider this information during the prosecution of the above-identified application. However, citation of these applications does not constitute an admission that the claims of the present application are substantially similar or similar to those of the applications listed above.

The filing of this Information Disclosure Statement (IDS) shall not be construed as a representation that a search has been made

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(37 C.F.R. 1.97(g)), an admission that the information cited is, or is considered to be, material to patentability, or that no other material information exists.

This IDS is being submitted concurrently with a Request for Continued Examination (RCE). Therefore, no fees should be due and this IDS should be fully considered on the merits, in accordance with 37 C.F.R. § 1.97(d).

The filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner. (Notice of January 9, 1992, 1135 O.G. 13-25, at 25.)

The person making this statement is the practitioner who signs below on the basis of information supplied by an individual associated with the filing and prosecution of this application (37 C.F.R. § 1.56(c)) and on the basis of information in the practitioner's file.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as Priority Mail in an package addressed to the "Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450", on March 3, 2004 by Shana Morda.

Richard P. Berg

Attorney for Applicant

Respectfully submitted,

Reg. No. 28,145

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Enclosures: Form PTO-1449 (modified) (1 page)

Copy of each document listed on Form PTO-1449

(modified)

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Form PTO-1449 (Modified)	ATTY DOCKET NO. B-3650 617089-5	u.s. serial no. 09/696,826	
LIST OF PATENTS AND PUBLICATIONS	APPLICANTS James P Baukus, et al.		
STATEMENT	FILING DATE October 25, 2000	<i>GROUP</i> 2811	

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUB- CLASS	FILING DATE or 102(e) DATE IF APPROPRIATE
	09/882,892		Baukus et al.			06/15/2001
	10/132,523		Clark Jr. et al.			04/24/2003
	10/735,841		Chow et al.	:		12/12/2003

FOREIGN PATENT DOCUMENTS

DOCUMENT NUMBER	ISSUE DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER	DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.